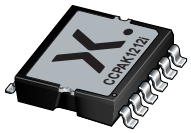


PSMN1R4-100CSF

NextPower 100 V, 1.35 mOhm, N-channel MOSFET in CCPAK1212i package

13 May 2024 **Objective data sheet**

1. General description

NextPower 100 V, standard level gate drive MOSFET. Qualified to 175 °C and recommended for high power industrial and consumer applications.

2. Features and benefits

- Low Q_{rr} for higher efficiency and lower spiking
- 400 Amps $I_{D(max)}$ continuous current rating
- Low $Q_G \times R_{DSon}$ FOM for high efficiency switching applications
- Strong avalanche energy rating (E_{as})
- Avalanche rated and 100% tested
- Ha-free and RoHS compliant CCPAK1212i package
- Inverted package, suitable for top-side cooling

3. Applications

- Battery protection
- High power full and half-bridge configurations
- BLDC motor control
- OR-ing

4. Quick reference data

Table 1. Quick reference data

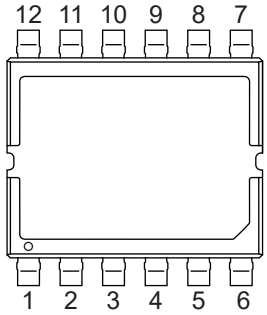
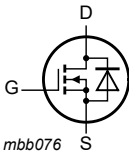
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_{DS}	drain-source voltage	25 °C ≤ T_j ≤ 175 °C		-	-	100	V
I_D	drain current	V_{GS} = 10 V; T_{mb} = 25 °C	[1]	-	-	400	A
P_{tot}	total power dissipation	T_{mb} = 25 °C; Fig. 1		-	-	1.071	kW
T_j	junction temperature			-55	-	175	°C
Static characteristics							
R_{DSon}	drain-source on-state resistance	V_{GS} = 10 V; I_D = 25 A; T_j = 25 °C		-	1.07	1.35	mΩ
		V_{GS} = 10 V; I_D = 25 A; T_j = 100 °C		-	[tbd]	[tbd]	mΩ
Dynamic characteristics							
Q_{GD}	gate-drain charge	I_D = 25 A; V_{DS} = 50 V; V_{GS} = 10 V; T_j = 25 °C; Fig. 2		-	48	-	nC
$Q_{G(tot)}$	total gate charge			[tbd]	248	[tbd]	nC
Avalanche ruggedness							
$E_{DS(AL)S}$	non-repetitive drain-source avalanche energy	I_D = 109 A; V_{sup} ≤ 100 V; R_{GS} = 50 Ω; V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; unclamped	[2]	-	-	1027	mJ

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Source-drain diode							
Q_r	recovered charge	I_S = 25 A; dI_S/dt = -100 A/µs; V_{GS} = 0 V; V_{DS} = 50 V; T_j = 25 °C; Fig. 3	[3]	-	85	-	nC

[1] Max current will be demonstrated through application tests. Practically the current will be limited by PCB, thermal design and operating temperature.
[2] Protected by 100% test
[3] includes capacitive recovery

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source		
2	S	source		
3	S	source		
4	S	source		
5	S	source		
6	G	gate		
7	D	drain		
8	D	drain		
9	D	drain		
10	D	drain		
11	D	drain		
12	D	drain		
mb	D	mounting base; connected to drain		

sot8005a_sv

CCPAK1212i (SOT8005A)

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PSMN1R4-100CSF	CCPAK1212i	Plastic, surface mounted copper clip package (CCPAK1212i); 12 terminals; 2.0 mm pitch, 12 mm × 12 mm × 2.5 mm body	SOT8005A

7. Limiting values

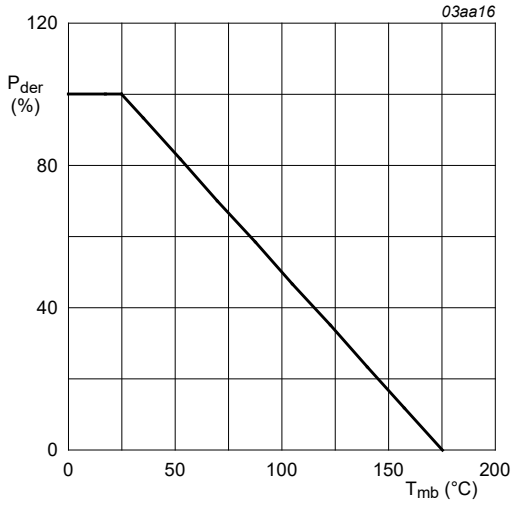
Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). T_j = 25 °C unless otherwise stated.

Symbol	Parameter	Conditions		Min	Max	Unit
V_{DS}	drain-source voltage	25 °C ≤ T_j ≤ 175 °C		-	100	V
V_{GS}	gate-source voltage			-20	20	V
P_{tot}	total power dissipation	T_{mb} = 25 °C; Fig. 1		-	1.071	kW
I_D	drain current	V_{GS} = 10 V; T_{mb} = 25 °C	[1]	-	400	A
		V_{GS} = 10 V; T_{mb} = 100 °C		-	282	A

Symbol	Parameter	Conditions		Min	Max	Unit
I_{DM}	peak drain current	pulsed; $t_p \leq$ 10 µs; T_{mb} = 25 °C		-	1600	A
T_{stg}	storage temperature			-55	175	°C
T_j	junction temperature			-55	175	°C
Source-drain diode						
I_S	source current	T_{mb} = 25 °C		-	400	A
I_{SM}	peak source current	pulsed; $t_p \leq$ 10 µs; T_{mb} = 25 °C		-	1600	A
Avalanche ruggedness						
$E_{DS(AL)S}$	non-repetitive drain-source avalanche energy	I_D = 109 A; $V_{sup} \leq$ 100 V; R_{GS} = 50 Ω; V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; unclamped	[2]	-	1027	mJ

[1] Max current will be demonstrated through application tests. Practically the current will be limited by PCB, thermal design and operating temperature.
[2] Protected by 100% test



$$P_{der} = \frac{P_{tot}}{P_{tot(25°C)}} \times 100\,\%$$

Fig. 1. Normalized total power dissipation as a function of mounting base temperature

8. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j\text{-}mb)}$	thermal resistance from junction to mounting base			-	[tbd]	0.14	K/W

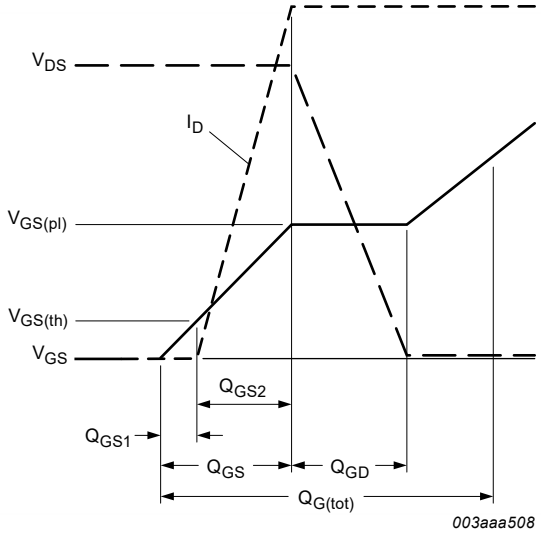
9. Characteristics

Table 6. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Static characteristics							
$V_{(BR)DSS}$	drain-source breakdown voltage	I_D = 250 µA; V_{GS} = 0 V; T_j = 25 °C		100	-	-	V
		I_D = 250 µA; V_{GS} = 0 V; T_j = -55 °C		90	-	-	V

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{GS(th)}$	gate-source threshold voltage	I_D = 1 mA; V_{DS}=V_{GS}; T_j = 25 °C		2	3	4	V
		I_D = 1 mA; V_{DS}=V_{GS}; T_j = 175 °C		-	1.6	-	V
		I_D = 1 mA; V_{DS}=V_{GS}; T_j = -55 °C		-	3.5	-	V
$\Delta V_{GS(th)}/\Delta T$	gate-source threshold voltage variation with temperature	25 °C ≤ T_j ≤ 150 °C		-	[tbd]	-	mV/K
I_{DSS}	drain leakage current	V_{DS} = 100 V; V_{GS} = 0 V; T_j = 25 °C		-	[tbd]	5	µA
		V_{DS} = 100 V; V_{GS} = 0 V; T_j = 125 °C		-	[tbd]	[tbd]	µA
I_{GSS}	gate leakage current	V_{DS} = 0 V; T_j = 25 °C		-	2	100	nA
				-	2	100	nA
R_{DSon}	drain-source on-state resistance	V_{GS} = 10 V; I_D = 25 A; T_j = 25 °C		-	1.07	1.35	mΩ
		V_{GS} = 7 V; I_D = 25 A; T_j = 25 °C		-	1.21	1.51	mΩ
		V_{GS} = 10 V; I_D = 25 A; T_j = 100 °C		-	[tbd]	[tbd]	mΩ
		V_{GS} = 10 V; I_D = 25 A; T_j = 175 °C		-	[tbd]	[tbd]	mΩ
R_G	gate resistance	f = 1 MHz; T_j = 25 °C		[tbd]	[tbd]	[tbd]	Ω
Dynamic characteristics							
$Q_{G(tot)}$	total gate charge	I_D = 25 A; V_{DS} = 50 V; V_{GS} = 10 V; T_j = 25 °C; Fig. 2		[tbd]	248	[tbd]	nC
		I_D = 0 A; V_{DS} = 0 V; V_{GS} = 10 V; T_j = 25 °C		-	128	-	nC
Q_{GS}	gate-source charge	I_D = 25 A; V_{DS} = 50 V; V_{GS} = 10 V; T_j = 25 °C; Fig. 2		[tbd]	72	[tbd]	nC
$Q_{GS(th)}$	pre-threshold gate-source charge	I_D = 25 A; V_{DS} = 50 V; V_{GS} = 10 V; T_j = 25 °C		-	48	-	nC
$Q_{GS(th-pl)}$	post-threshold gate-source charge			-	24	-	nC
Q_{GD}	gate-drain charge	I_D = 25 A; V_{DS} = 50 V; V_{GS} = 10 V; T_j = 25 °C; Fig. 2		-	48	-	nC
$V_{GS(pl)}$	gate-source plateau voltage	I_D = 25 A; V_{DS} = 50 V; T_j = 25 °C		-	[tbd]	-	V
C_{iss}	input capacitance	V_{DS} = 50 V; V_{GS} = 0 V; f = 0.5 MHz; T_j = 25 °C		[tbd]	17737	[tbd]	pF
C_{oss}	output capacitance			[tbd]	3984	[tbd]	pF
C_{rss}	reverse transfer capacitance			[tbd]	63	[tbd]	pF
$t_{d(on)}$	turn-on delay time	V_{DS} = 50 V; R_L = 2 Ω; V_{GS} = 10 V; $R_{G(ext)}$ = 5 Ω; T_j = 25 °C		-	65	-	ns
t_r	rise time			-	55	-	ns
$t_{d(off)}$	turn-off delay time			-	146	-	ns
t_f	fall time			-	72	-	ns
Source-drain diode							
V_{SD}	source-drain voltage	I_S = 25 A; V_{GS} = 0 V; T_j = 25 °C		-	[tbd]	1	V
t_{rr}	reverse recovery time	I_S = 25 A; dI_S/dt = -100 A/µs; V_{GS} = 0 V; V_{DS} = 50 V; T_j = 25 °C; Fig. 3		-	83	-	ns
Q_r	recovered charge		[1]	-	85	-	nC

[1] includes capacitive recovery



T_j = 25 °C; I_D = A

Fig. 2. Gate-source voltage as a function of gate charge; typical values

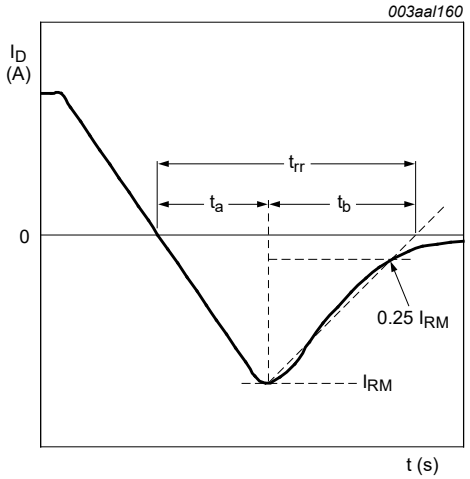
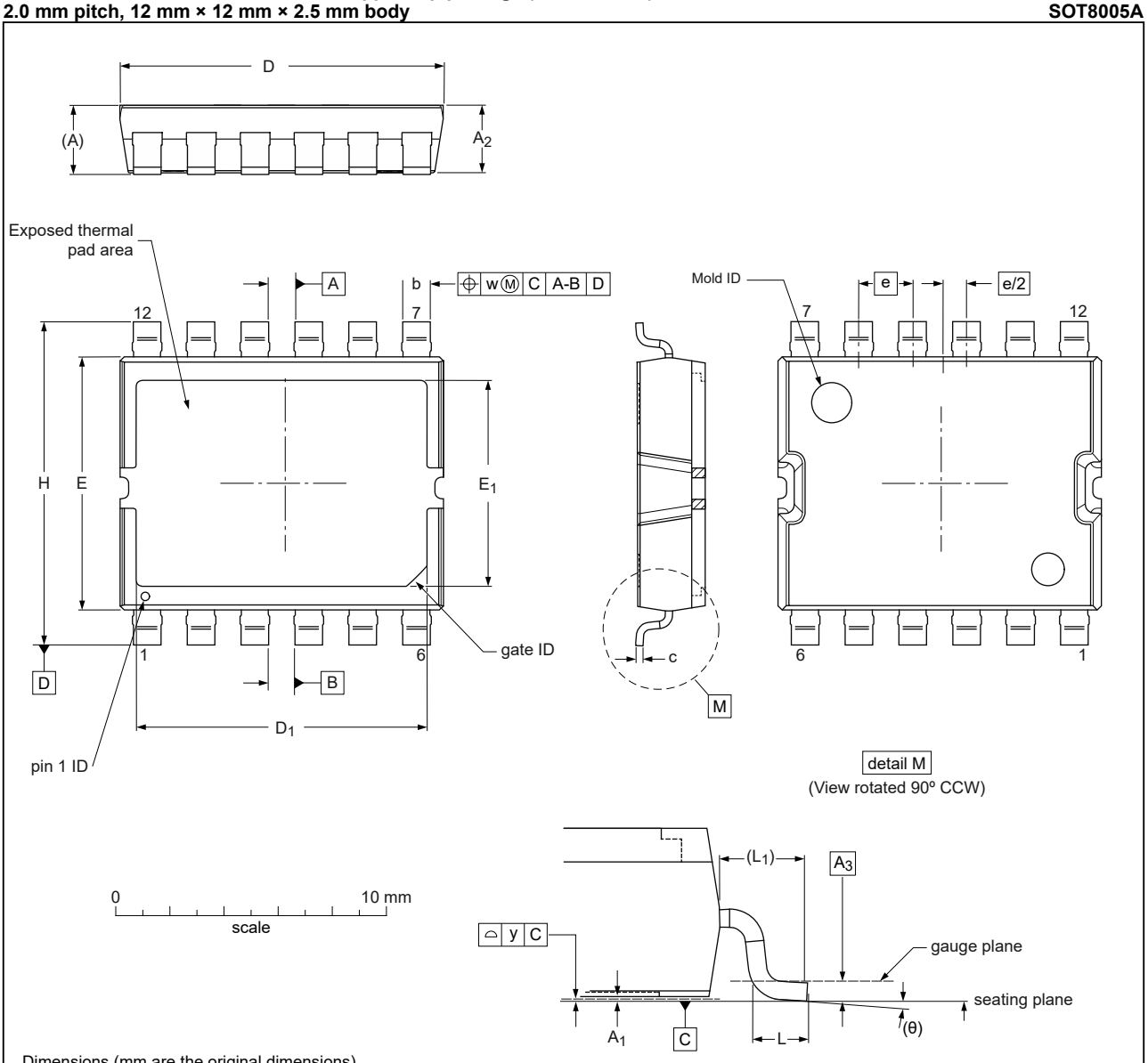


Fig. 3. Reverse recovery timing definition

10. Package outline

SOT8005A: Plastic, surface mounted copper clip package (CCPAK1212i); 12 terminals; 2.0 mm pitch, 12 mm × 12 mm × 2.5 mm body **SOT8005A**



Dimensions (mm are the original dimensions)

Unit[1]		A(ref)	A_1	A_2	A_3	b	c	D	D_1	E	E_1	e	H	L	L_1(ref)	w	y	θ(ref)
mm	max		0.13	2.65		1.12	0.30	12.15	10.95	9.55	7.40		12.15	1				
	nom	2.75			0.25							2.0			1.3	0.20	0.1	4°
	min		0	2.4		0.93	0.22	11.85	10.65	9.25	7.10		11.85	0.6				

Note
1. Plastic or metal protrusions of 0.15 mm maximum per side are not included for dimension D.
2. Plastic or metal protrusions of 0.25 mm maximum per side are not included for dimension E.

sot8005a_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT8005A		MO-359				~~24-02-07~~ 24-04-16

Fig. 4. Package outline CCPAK1212i (SOT8005A)

11. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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[2] The term 'short data sheet' is explained in section "Definitions".
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